

Disabling the Internal Oscillator on the VC5503/C5506/C5507/C5509/C5509A DSP

Monideep Mukherjee and Hitoshi Sato

C5000 DSP System Applications, C5000 Design

ABSTRACT

This application report contains information and examples on how to disable the internal clock oscillator on the TMS320VC5503, TMS320VC5506, TMS320VC5507, TMS320VC5509, and TMS320VC5509A DSPs to minimize power consumption. The document contains an overview of how the internal clock oscillator operates, and how to disable it as part of the IDLE power-down feature. It also discusses how to wake up the oscillator from an IDLE power down.

Contents

1	Overview of IDLE Operations	2
2	Disabling the Internal Oscillator.....	4
3	Enabling the Internal Oscillator	7
4	References	11

List of Figures

1	Internal System Oscillator External Crystal	2
2	TMS320VC5509 USB Clock Generator	3
3	TMS320VC5506/C5507/C5509A USB Clock Generator	4
4	Disabling the Internal Oscillator on the TMS320VC5509	5
5	Disabling the Internal Oscillator on the TMS320VC5507/C5509A	6
6	Waking Up the Internal Oscillator With a Hardware or USB Reset/Resume for the TMS320VC5509	8
7	Waking Up the Internal Oscillator With an RTC or External Interrupt for the TMS320VC5506/C5507/C5509.....	9
8	Waking Up the Internal Oscillator With a Hardware or USB Reset/Resume for the TMS320VC5506/C5507/C5509/C5509A	10
9	Waking Up the Internal Oscillator With an RTC or External Interrupt for the TMS320VC5506/C5507/C5509/C5509A.....	11

1 Overview of IDLE Operations

A critical component of power conservation is minimizing the power used when an application is in an idle or low-activity state. The DSP incorporates low-activity power management through the implementation of user-controllable IDLE domains. These domains are sections of the device that can be selectively enabled or disabled under software control. When disabled, a domain enters a very low-power idle state in which memory contents are still maintained. When the domain is enabled, it returns to normal operations. The various domains include the central processing unit (CPU), direct memory access (DMA), peripherals, external memory interface (EMIF), and the clock-generation circuitry. For maximum power conservation, the IDLE power-down feature is most commonly used. This feature stops the CPU, DMA, and EMIF domains, except for the internal oscillator with external crystal resonator that is connected to pins X1 and X2/CLKIN. This is shown in [Figure 1](#).

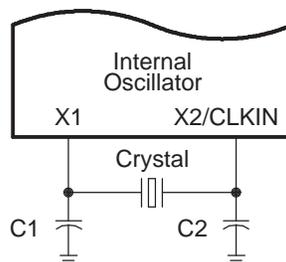


Figure 1. Internal System Oscillator External Crystal

There is a distinction between clock-generation circuitry and the internal oscillator. The clock-generation circuitry refers to the phase-lock loops (PLLs) that are within the DSP. The phase-lock loops provide clock signals to the various internal peripherals and digital signal processor (DSP) core.

The internal oscillator is the input clock source to the clock-generation PLLs. The internal oscillator is not the crystal resonator, but is the circuitry inside the DSP that drives the crystal to oscillate. By turning off the oscillator, you can further reduce the amount of current consumed. This document outlines, step by step, how to turn OFF the internal oscillator using software as part of the IDLE power-down feature.

The DSP includes two independent clock generators that are sourced by the internal oscillator: the DSP clock generator and the universal serial bus (USB) clock generator. Both clock generators are similar in operation and functionality. The DSP clock generator supplies the clock that is used by the CPU, and all of the other peripherals inside the DSP. The USB clock generator supplies the clock needed to operate the USB peripheral.

The TMS320VC5509 USB clock generator consists of a digital phase lock loop (DPLL) as shown in Figure 2.

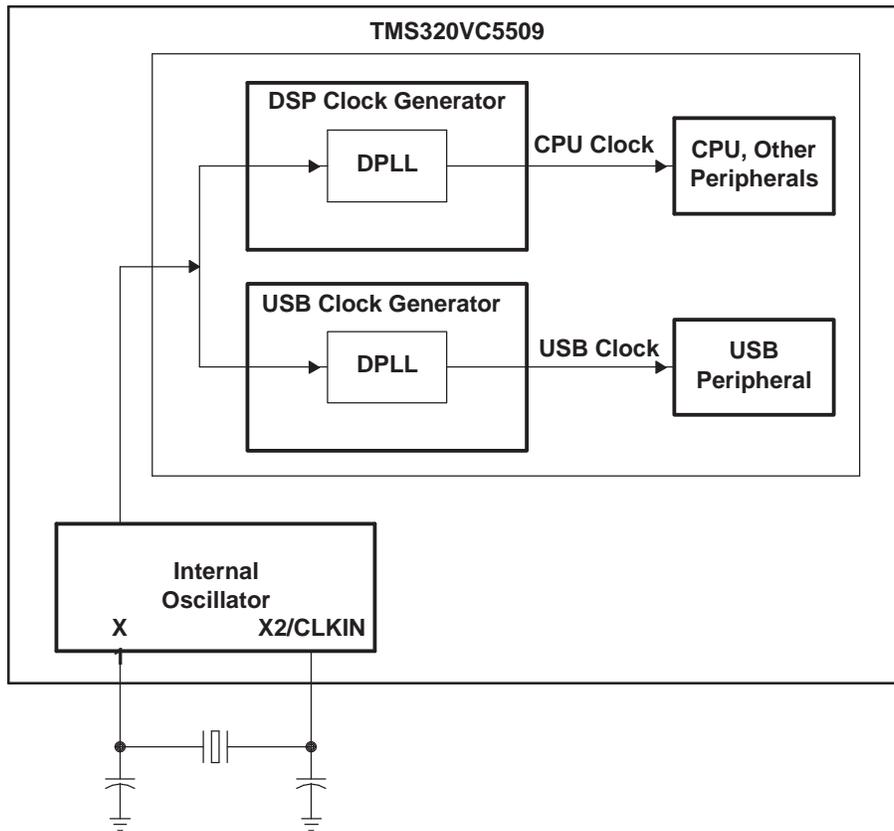


Figure 2. TMS320VC5509 USB Clock Generator

The C5506, C5507, and C5509A USB clock generators consist of an analog phase locked loop (APLL) as well as a DPLL. [Figure 3](#) shows a diagram of the internal oscillator and its relationship to the clock generators.

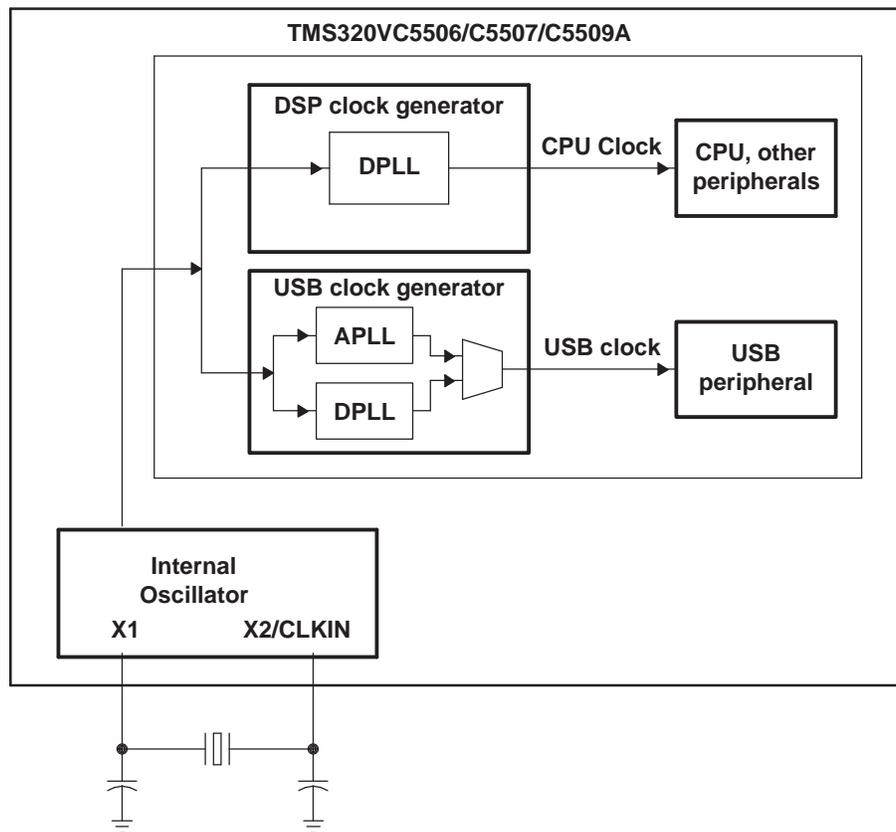


Figure 3. TMS320VC5506/C5507/C5509A USB Clock Generator

Each clock generator also incorporates an IDLE mode for power conservation. It can be placed in its IDLE mode by turning off the CLKGEN IDLE domain in the IDLE configuration register (ICR). When the clock generator is idled, the output clock is stopped and held high. The IDLE status register (ISR) indicates which domains are currently idled, and the ICR indicates which domains will be active the next time the IDLE instruction is executed. Please note that the TMS320VC5506/C5507/C5509A USB APLL is not part of the USB CLKGEN and cannot be IDLEd. To idle the USB PLL, you have to switch to the USB DPLL from the APLL and then enter IDLE. For details on this procedure, see *Using the USB APLL on the TMS320VC5506/C5507/C5509A* ([SPRA997](#)).

The DSP and USB clock generators are independent. If an IDLE instruction turns off the DSP clock generator, the USB module can keep running and vice versa. If either the DSP clock generator or the USB clock generator are idled using the IDLE power-down feature, the internal clock oscillator remains active. To disable the internal clock oscillator, both the DSP clock generator and the USB clock generator must be enabled before the IDLE power-down sequence can be initiated. This is also true for the case where a system does not incorporate a USB port or interface.

2 Disabling the Internal Oscillator

[Figure 4](#) shows a complete block diagram and step-by-step details on how to disable the internal clock oscillator for the TMS320VC5509. [Figure 5](#) shows the same procedure for the TMS320VC5506/C5507C/C5509A. Please note that if the on-chip emulation is used on the TMS320VC5506/C5507/C5509A, you must disconnect the emulator for the device to go into IDLE properly. If the emulator is left connected, the DSP will not go into IDLE.

Attached with this document is a sample assembly program that demonstrates the oscillator disable process for [Figure 5](#).

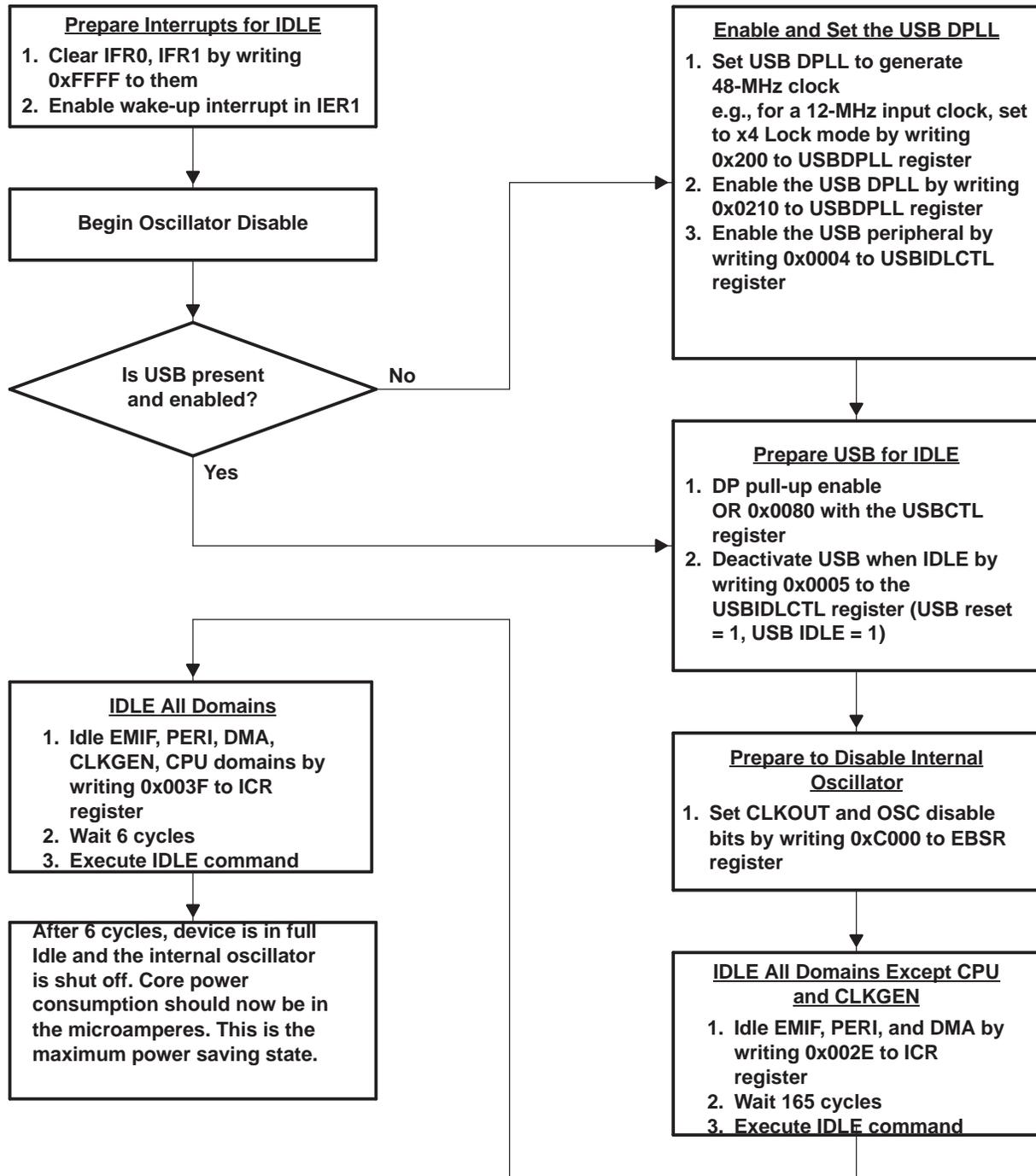


Figure 4. Disabling the Internal Oscillator on the TMS320VC5509

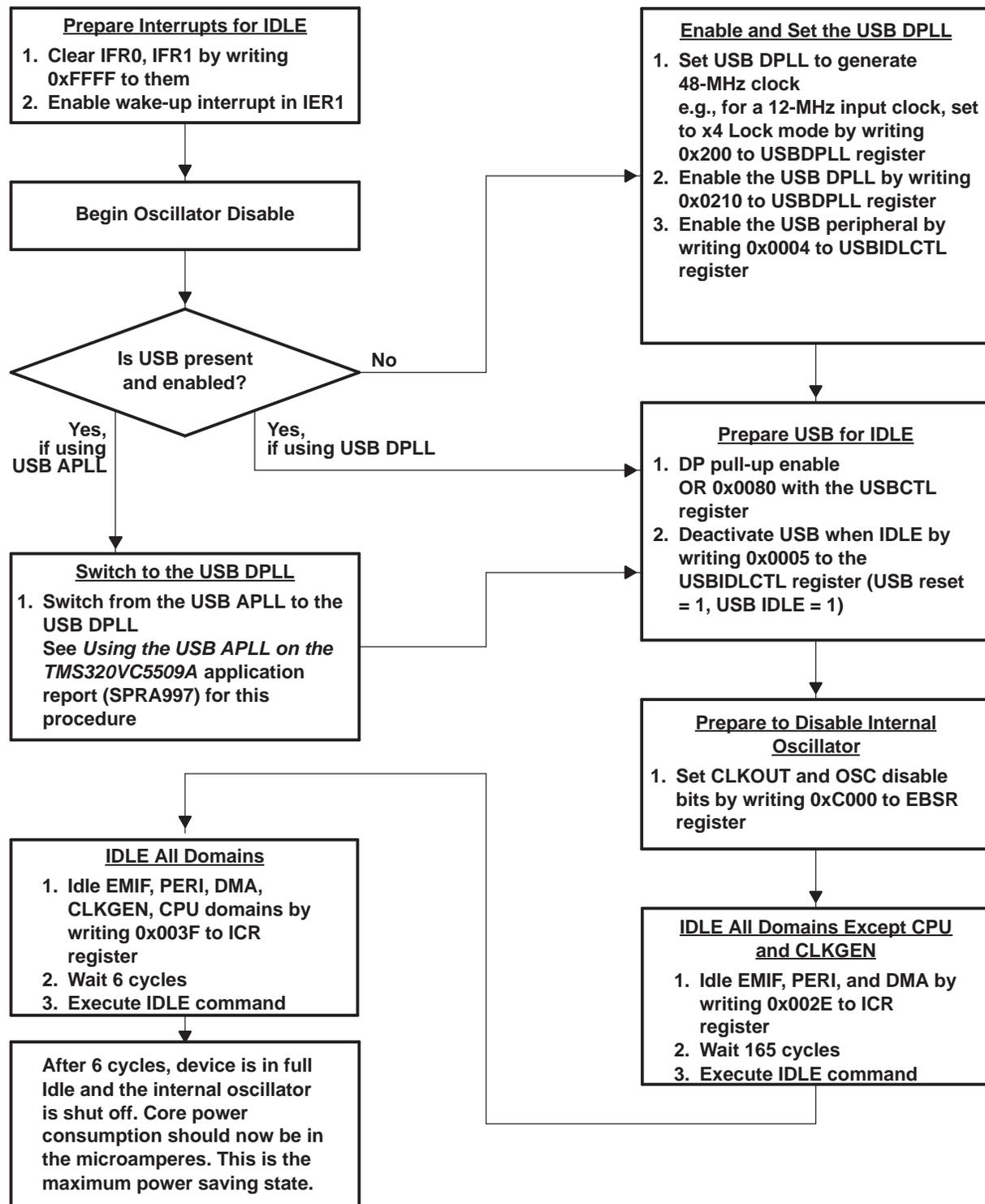


Figure 5. Disabling the Internal Oscillator on the TMS320VC5507/C5509A

3 Enabling the Internal Oscillator

The internal oscillator can be awakened from IDLE mode with any of the four events shown below:

- Hardware RESET
- USB resume/reset events
- Real-time clock (RTC) interrupt
- External interrupt

Please note that all external interrupts are automatically masked when powering up from an IDLE state. This is needed because it gives the oscillator time to stabilize when being powered up. The TMS320VC5503, TMS320VC5506, TMS320VC5507, TMS320VC5509, and TMS320VC5509A use the USB DPLL as the time keeper, to allow time for this to happen. Therefore, if USB DPLL is not set up correctly, external interrupts will not be re-activated after wake up.

After wake up, the INTM bit in the status register ST1, and the respective IER register bits for the various interrupts, should be set to enable the CPU to execute interrupt service routines.

Also, note that after wakeup only the CLKGEN and CPU domains are awakened. It is your responsibility to enable the other domains by clearing the IDLEEN bit and setting the ICR appropriately. Afterwards, you must use the IDLE command to execute these changes. The IDLE command is not pipeline protected, so extra cycles are required between the ICR assignment and the IDLE command (6 cycles are recommended). For more details on pipeline protection and operation, see the *TMS320C55x DSP Programmer's Guide* ([SPRU376](#)).

Any wake-up event must consider the oscillator stabilize time. Since typically, most oscillators take at least 100-200 ms to stabilize, any wake-up event must typically be asserted for 10 CPU clock cycles + oscillator stabilize time. Oscillator stabilize time can be obtained for the specific manufacturer's oscillator being used.

For each system, you must evaluate the oscillator stabilization time. This is an analog parameter that is affected by the board parasitics, crystal characteristics, temperature, and I/O supply voltage. Also, the ESR and the load capacitance (including parasitic capacitance) of the oscillator circuit influence the oscillator stability time. Lower DV_{DD} voltages require longer oscillator stabilization times, and lower CV_{DD} require longer PLL lock times.

You must wait for 1ms after the PLL lock bit is set before the PLL wrapper has locked onto the PLL clock and switches from the bypass clock to the new PLL clock. After the PLL lock bit is set, the PLL core has locked onto the oscillator clock, and will be outputting the PLL clock to the PLL wrapper. If you do not wait for the PLL wrapper to output the PLL clock to the rest of the chip, the CPU could potentially latch up if it is still running in bypass mode and trying to interface with faster devices.

Figure 6 and Figure 7 show each of the wake up procedures for TMS320VC5509 and the TMS320VC5506/C5507/C5509A, respectively, in detail.

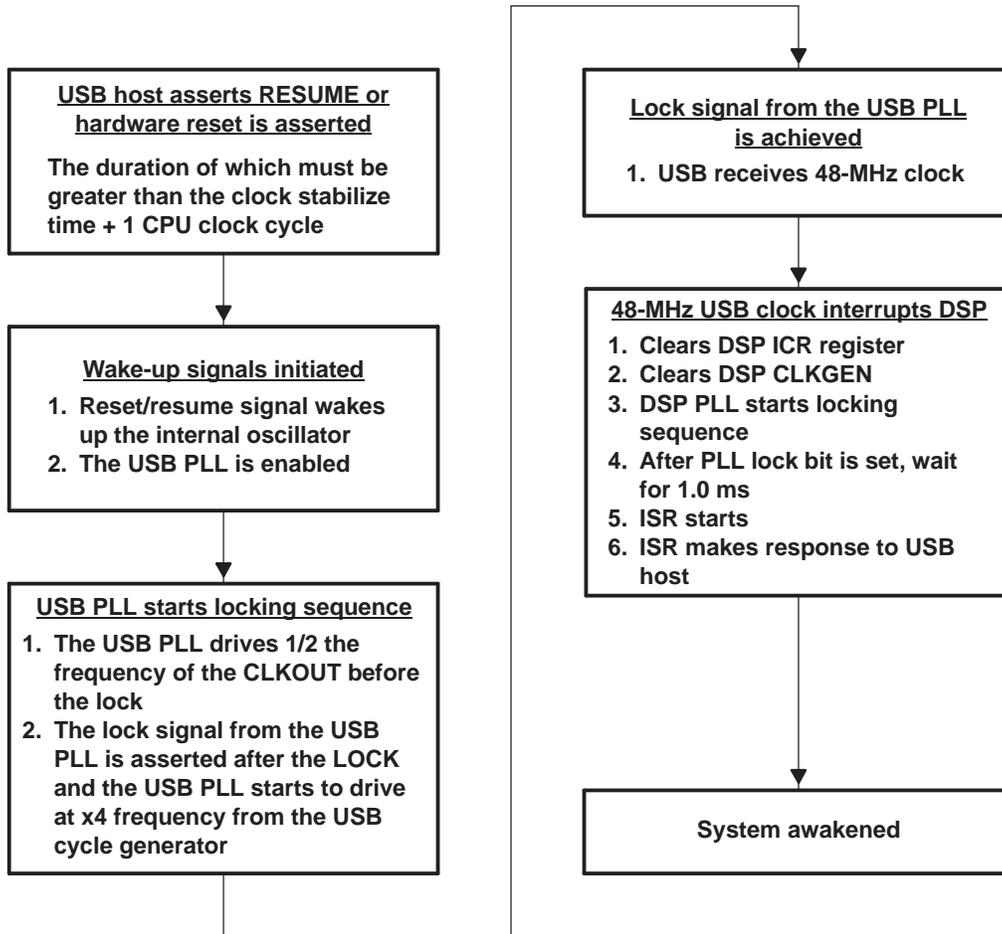


Figure 6. Waking Up the Internal Oscillator With a Hardware or USB Reset/Resume for the TMS320VC5509

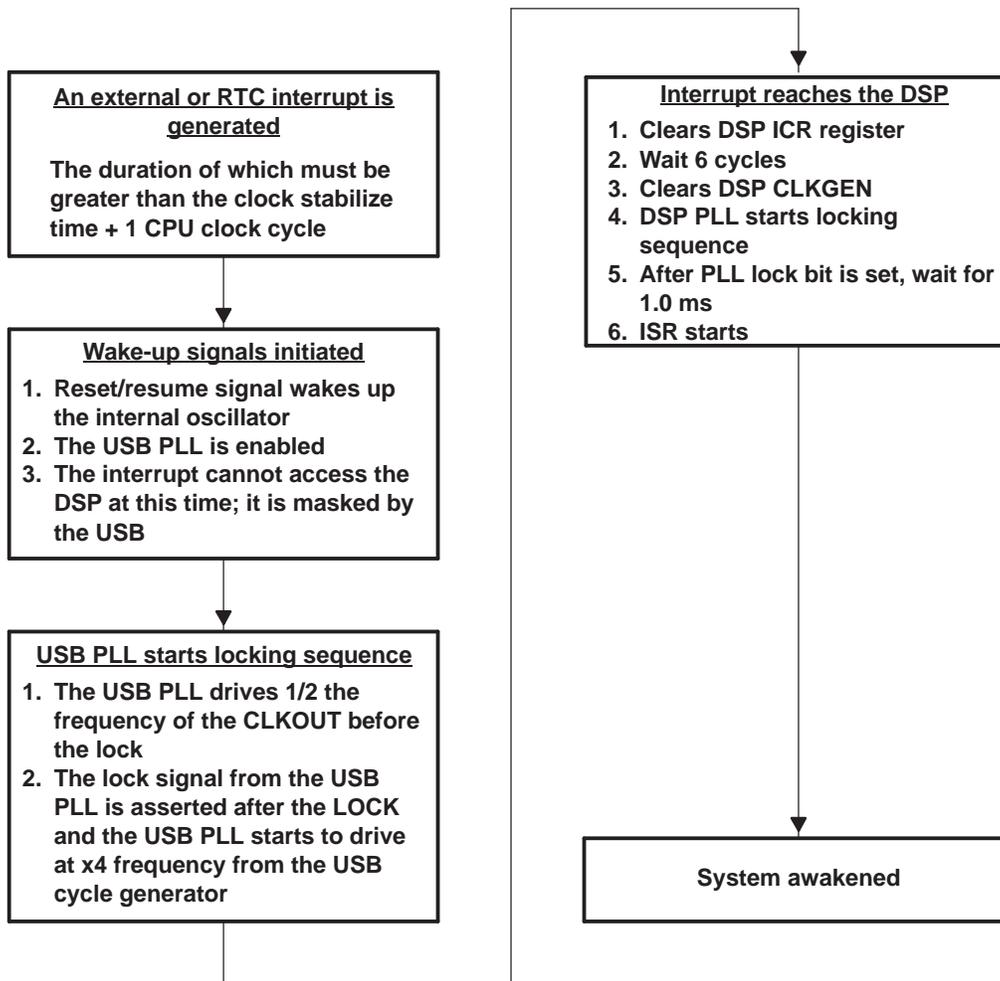


Figure 7. Waking Up the Internal Oscillator With an RTC or External Interrupt for the TMS320VC5506/C5507/C5509

Figure 8 and Figure 9 show each of the wake up procedures for TMS320VC5506/C5507/C5509/C5509A in detail.

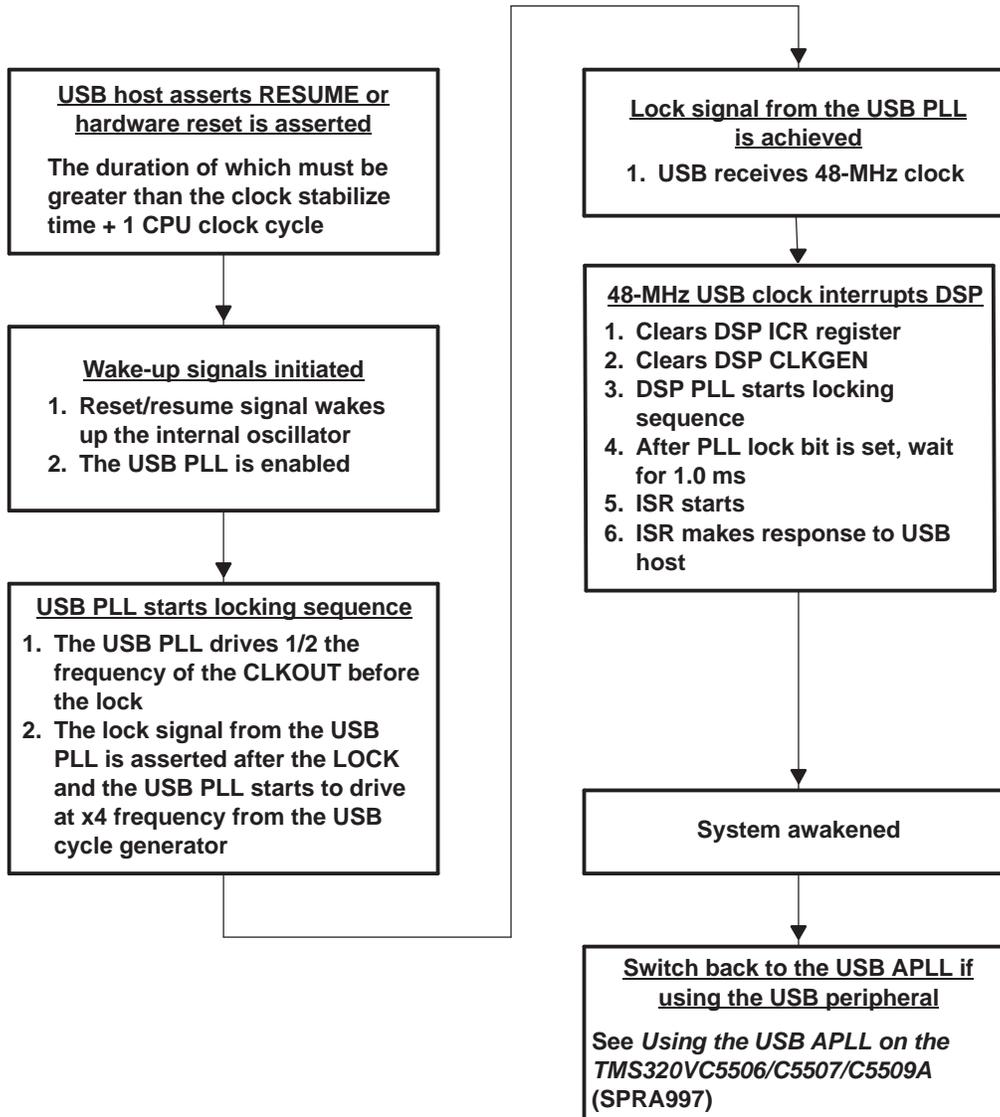


Figure 8. Waking Up the Internal Oscillator With a Hardware or USB Reset/Resume for the TMS320VC5506/C5507/C5509/C5509A

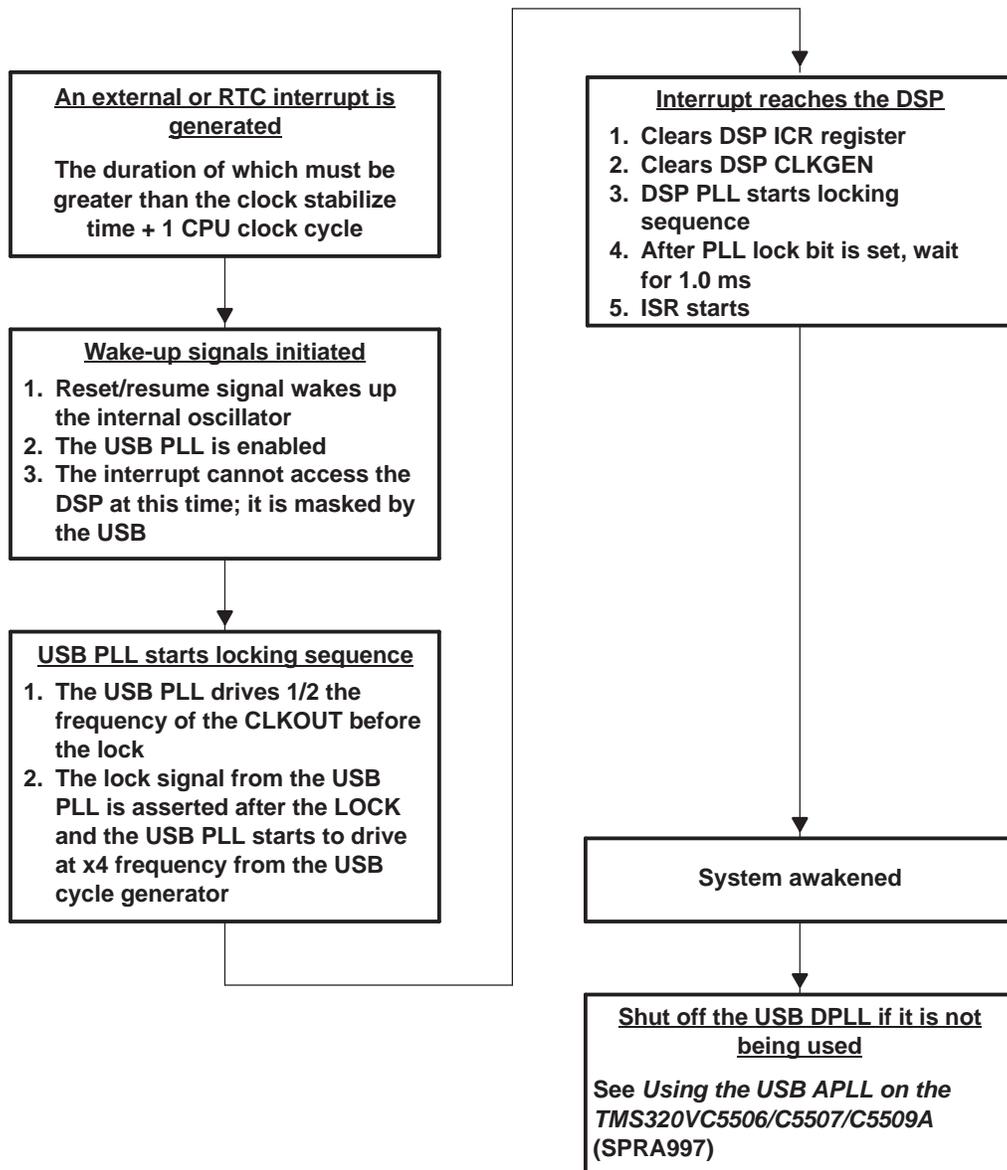


Figure 9. Waking Up the Internal Oscillator With an RTC or External Interrupt for the TMS320VC5506/C5507/C5509/C5509A

4 References

- *Using the USB APLL on the TMS320VC5506/C5507/C5509A* ([SPRA997](#))
- *TMS320C55x DSP Programmer's Guide* ([SPRU376](#))

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products

Amplifiers	amplifier.ti.com
Data Converters	dataconverter.ti.com
DSP	dsp.ti.com
Clocks and Timers	www.ti.com/clocks
Interface	interface.ti.com
Logic	logic.ti.com
Power Mgmt	power.ti.com
Microcontrollers	microcontroller.ti.com
RFID	www.ti-rfid.com
RF/IF and ZigBee® Solutions	www.ti.com/lprf

Applications

Audio	www.ti.com/audio
Automotive	www.ti.com/automotive
Broadband	www.ti.com/broadband
Digital Control	www.ti.com/digitalcontrol
Medical	www.ti.com/medical
Military	www.ti.com/military
Optical Networking	www.ti.com/opticalnetwork
Security	www.ti.com/security
Telephony	www.ti.com/telephony
Video & Imaging	www.ti.com/video
Wireless	www.ti.com/wireless

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2008, Texas Instruments Incorporated